[®]ZiLŒ

(MARCOM) DC4042 DOCUMENT CONTROL MASTER

CUSTOMER PROCUREMENT SPECIFICATION

Z88C00/01 CMOS SUPER8®

ROMLESS MCU

GENERAL DESCRIPTION

The CMOS Super8[®] offers new flexibility and sophistication in 8-bit microcontrollers. The Super8 offers all the features necessary for industrial, consumer, and automotive applications with an enhanced feature set in CMOS technology. At the same time, the CMOS Super8 retains full pin-for-pin compatibility with the NMOS Super8. Available in 48-pin DIP, and 44-, 68-pin PLCC, the CMOS Super8 is the last word in general purpose controllers.

The Super8 features a full-duplex, Universal Asynchronous Receiver/Transmitter (UART) with on-chip baud rate generator, on-chip oscillator, and a Direct Memory Access controller (DMA).

Notes:

All Signals with a preceding front slash, "/", are active Low, e.g.: B/W (WORD is active Low); /B/W (BYTE is active Low, only).

Power connections follow conventional descriptions below:

Connection	Circuit	Device	
Power	V _{cc}	V _{DD}	
Ground	GND	V _{ss}	

GENERAL DESCRIPTION (Continued)



* Only when used as demux'ed external memory bus.

Functional Block Diagram

GENERAL DESCRIPTION (Continued)





68-Lead	PLCC	Pin	Assignments
---------	------	-----	-------------

Pin #	Symbol	Function	Direction	Pin #	Symbol	Function	Direction
1 2-7 8-10 11 12	N/C P15-10 N/C V _{cc} De-Mux	Not Connected Port 1, Pins 0,1,2,3,4,5 Not Connected Power Supply De-multiplex Pin	In/Output Input Input	37 38-39 40-41 42 43-44	P30 P27-26 P37-36 /RESET NC	Port 3, Pin 0 Port 2, Pins 6,7 Port 3, Pins 7,6 RESET Not Connected	In/Output In/Output In/Output Input
13-14 15-16 17 18 19	P17-16 P25-24 V _{cc} GND V _{cc}	Port 1, Pins 6,7 Port 2, Pins 4,5 Power Supply Ground Power Supply	In/Output In/Output Input Input Input	45 46-47 48-49 50-51 52	R//W P43-42 GND P41-40 /DS	READ/WRITE Port 4, Pins 3,2 Ground Port 4, Pins 1,0 Data Strobe	Output In/Output Input In/Output Output
20 21 22-25 26-27 28	XTAL2 XTAL1 P47-44 N/C P22	Crystal Oscillator Crystal Oscillator Port 4, Pins 4,5,6,7 Not Connected Port 2, Pin 2	Output Input In/Output In/Output	53 54-55 56-57 58 59-61	/AS P35-34 P07-06 V _{cc} N/C	Address Strobe Port 3, Pins 4,5 Port 0, Pins 7,6 Power Supply Not Connected	Output In/Output In/Output Input
29 30-31 32-34 35 36	N/C P33-32 P23-21 P31 N/C	Not Connected Port 3, Pins 2,3 Port 2, Pins 3,0,1 Port 3, Pin 1 Not Connected	In/Output In/Output In/Output	62-67 68	P05-00 GND	Port 0, Pins 5,4,3,2,1,0 Ground	In/Output Input

	-				
P10		1	\bigcirc	48	P00
P11		2		47	P01
P12	Д	з		46	P02
P13	Ц	4		45	P03
P14	Ц	5		44	P04
P15	Ц	6		43	P05
P16	Ц	7		42	P06
P17	Ц	8		41	P07
P24	Ц	9		40	P34
P25		10		39	P35
+5V	Ц	11		38	/AS
XTAL2	d	12	Z88C00	37	/DS
XTAL1		13	DIP	36	P40
P44	Ц	14		35	P41
P45	d	15		34	GND
P46	Ц	16		33	P42
P47	d	17		32	P43
P22		18		31	R//W
P32		19		30	/RESET
P33	Ц	20		29	P36
P23		21		28	P37
P20		22		27	P27
P21		23		26	P26
P31		24		25	P30
	L				

48-Lead I	DIP	Pin	Identification
-----------	-----	-----	----------------

48-Lead DIP Pin Assignments

Pin #	Symbol	Function	Direction	Pin #	Symbol	Function	Direction
1-8	P17-10	Port 1, Pins 0,1,2,3,4,5,6,7	In/Output	28-29	P37-36	Port 3, Pins 7,6	In/Output
9-10	P25-24	Port 2, Pins 4,5	In/Output	30	/RESET	RESET	Input
11	V _{cc}	Power Supply	Input	31	R//W	READ/WRITE	Output
12	XTAL2	Crystal Oscillator	Output	32-33	P43-42	Port 4, Pins 3,2	In/Output
13	XTAL1	Crystal Oscillator	Input	34	GND	Ground	Input
14-17	P47-44	Port 4, Pins 4,5,6,7	In/Output	35-36	P41-40	Port 4, Pins 1,0	In/Output
18	P22	Port 2, Pin 2	In/Output	37	/DS	Data Strobe	Output
19-20 21-23 24-25 26-27	P33-32 P23-21 P31-30 P27-26	Port 3, Pins 2,3 Port 2, Pins 3,0,1 Port 3, Pins 1,0 Port 2, Pins 6,7	In/Output In/Output In/Output In/Output	38 39-40 41-48	/AS P35-34 P07-00	Address Strobe Port 3, Pins 5,4 Port 0, Pins 7,6,5,4,3,2,1,0	Output In/Output In/Output

ABSOLUTE MAXIMUM RATINGS

Symbol	Description	Min	Max	Units
V _{cc}	Supply Voltage (*)	-0.3	+7.0	V
V _{CC} T _{STG} T	Storage Temp	-65°	+150°	С
T	Oper Ambient Temp		†	С

Notes:

* Voltage on all pins with respect to GND.

† See Ordering Information.

STANDARD TEST CONDITIONS

The characteristics listed below apply for standard test conditions as noted. All voltages are referenced to V_{ss} Positive current flows into the referenced pin (Standard Test Load).

Standard conditions are:

- 4.5V < V_{cc} < 5.5V GND 0V
- $-40^{\circ}\text{C} < \text{T}_{A} < +105^{\circ}\text{C}$



Stress greater than those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for an extended pe-

riod may affect device reliability.

Standard Test Load

ADDITIONAL FEATURE

Weak Latches

All input pins on the Super8* will be provided with weak latches. Weak latches on inputs prevent them from floating and reduces unnecessary current flow. Weak latches on inputs are automatically disabled when the corresponding output is configured as open-drain.



44-Lead PLCC Pin Identification

44-Lead PLCC Pin Identification

Pin #	Symbol	Function	Direction	Pin #	Symbol	Function	Direction
1-6	P15-10	Port 1, Pins 0,1,2,3,4,5	In/Output	23-24	P31-30	Port 3, Pins 1,0	In/Output
7	N/C	Not Connected		25-26	P27-26	Port 2. Pins 8.7	In/Output
8-9	P17-16	Port 1, Pins 6,7	In/Output	27-28	P37-36	Port 3, Pins 7,8	In/Output
10-11	P25-24	Port 2, Pins 4,5	In/Output	29	/RESET	Reset	Input
12	V _{cc}	Power Supply	Input	30	R//W	Read/Write	Output
13	GŇD	Ground	Input	31	GND	Ground	Input
14	XTAL2	Crystal Oscillator	Output	32	/DS	Data Strobe	Output
15	XTAL1	Crystal Oscillator	Input	33	/AS	Address Strobe	Output
16	P47	Port 4, Pin 7	In/Output	34-35	P35-34	Port 3, Pins 5,4	In/Output
17	P22	Port 2, Pin 2	In/Output	36-37	P07-06	Port 0, Pins 7,6	In/Output
18-19	P33-32	Port 3, Pins 2,3	In/Output	38	V _{cc}	Power Supply	Input
20-22	P23-21	Port 2, Pins 3.0,1	In/Output	39-44	P05-00	Port 0, Pins 5,4,3,2,1,0	In/Output

AC ELECTRICAL CHARACTERISTICS

External I/O or Memory Read and Write Timing

			Nor	mai	Extended	
Number	Symbol	Parameter	Min	Max	Min	Max
1	TdA(AS)	Address valid to /AS Rise Delay	25		50	
2	ThAS(A)	AS Rise to Address Valid Hold Time	35		85	
3	TdAS(DI)	/AS Rise to Data In Required Valid Delay		150		335
4	TwAS	/AS Low Width	35		85	
5	TdAZ (DSR)	Address Float to /DS (Read)	0		0	
6	TwDSR	/DS (Read) Low Width	125		275	
7	TwDSW	/DS (Write) Low Width	65		165	
8	TdDSR (DI)	/DS (Read) to Data In Required Valid Delay		80		225
9	ThDSR(DI)	/DS Rise (Read) to Data In Hold Time	0		0	
10	TdDS (A)	/DS Rise to Address Active Delay	20		70	
11	TdDA (AS)	/DS Rise to /AS Delay	30		80	
12	TdR/W (AS)	R/W to AS Rise Delay	20		70	
13	TdDS (R/W)	DS Rise to R/W Valid Delay	40		90	
14	TdDO (DSW)	Data Out to /DS (Write) Delay	10		50	
15	ThDSW (DO)	/DS Rise (Write) to Data Out Hold Time	20		85	
16	TdA (DI)	Address to Data In Required Valid Delay		205		385
17	TdAS (DSR)	/AS Rise to D/S (Read) Delay	50		95	
19	TdDM (AS)	/DM to /AS Rise Delay	28		70	
20	TdDS (DM)	/DS Rise to /DM Valid Delay	33		85	
21	ThDS (A)	/DS Rise to Address Valid Hold Time	36		90	
22	TwW	Wait Width (One Wait) Window	[1]		[1]	
23	TdAS (W)	/AS Rise to Wait Delay		90		335

Notes:

[1] Not characterized function, guaranteed by design.

The value of TsDI (DSR) has been measured for the NMOS part as mentioned below as TsDI (DSR) old. This "old" value needs to be relaxed as to the value described as

TsDI (DSR) new. This new value will allow the customer to use external memories with slower access times that immediately translates in lower cost.

DC CHARACTERISTICS

Symbol	Parameter	Min	Max	Unit	Condition
V _{CH}	Clock Input High Voltage	3.8	V _{cc}	V	Driven by External Clock Generator
V _{CL}	Clock Input Low Voltage	-0.3	V _{cc} 0.8	V	Driven by External Clock Generator
V _{IH}	Input High Voltage	$0.7 V_{cc}$		V	,
V	Input Low Voltage	-0.3 č	V _{cc} 0.15 V _{cc}	V	
V _{RH}	Reset Input High Voltage	3.8	V _{cc} ^{CC}	V	
V _{RL}	Reset Input Low Voltage	-0.3	0.8	V	
V _{OH}	Output High Voltage	2.4		V	l _{αu} =-400 μA
V _{OL}	Output Low Voltage		0.4	V	l _{oH} =-400 μA I _{OF} =+4.0 mA
V _{IL}	Input Leakage	-10	10	μA	86
	Output Leakage	-10	10	μA	
l _{in}	Reset Input Current		-50	μA	
l _{cc}	V _{cc} Standby Current		90	mA	[1]

Notes:

Estimated Values

[1] In this case all outputs and I/O pins are floating.

INTERLOCKED MODE HANDSHAKE TIMING



Input Handshake Timing Fully Interlocked Mode





AC ELECTRICAL CHARACTERISTICS

Interlocked Mode Handshake Timing

No.	Symbol	Parameter	Notes (Data Direction)
	TsDI (DAV)	Data in Setup Time to /DAV	In
2	ThRDY (DI)	RDY to Data in Hold Time	ln
3	TwDAV	/DAV Width	In
1	TdDAV (RDY)	/DAV to RDY Delay	In
5	TwDAV (RDY)	DAV^ to RDY Wait Time	In
6	TdRDY (DAV)	RDY^ to /DAV Delay	ln
7	TdD0 (DAV)	Data Out to /DAV Delay	Out
3	TdDAVd (RDY)	DAV to RDY Delay	Out
9	TdRDY (DAV)	RDY to /DAV^ Delay	Out
10	TwRDY	RDY Width	Out
11	TwRDY (DAV)	RDY^ to /DAV Wait Time	Out

20 MHZ NORMAL TIMING



External Memory Read And Write

Z88C00 ERRATA

1. Handshake Port 4

Input handshake (strobe and fully interlocked mode) with DMA is not functional.

2. UART Receive

Upon receiving a character, the RCA (receive character available) interrupt is serviced twice. The time between two consecutive interrupts at 14 MHz is 53 μ s. Although the UIO is read, which normally should clear the interrupt source, the RCA interrupt is asserted twice.

3. TTL Levels

 V_{IH} , V_{IL} do not meet the TTL specification when the port is used as control inputs for the counter/timers, UART, handshake, external wait and interrupts. Instead $V_{IH} =$ 0.7 V_{cc} and $V_{IL} = 0.15 V_{cc}$. 4. DMA Usage

No DMA can be performed to external memories if the wait feature (hardware wait and software wait) is used.

- Reset Software Sequence After a hardware reset, program the POM register before the PM register.
- 6. Counter/Timers

To obtain a 2.5 MHz signal from the counter/timers, load the Counter/Timer registers with FFFFH and count up. The equivalent operations for the NMOS part to obtain the 2.5 MHz signal is to load the counter/timers with 0000H and count down.

Low Margin:

Customer is advised that this product does not meet Zilog's internal guardbanded test policies for the specification requested and is supplied on an exception basis. Customer is cautioned that delivery may be uncertain and that, in addition to all other limitations on Zilog liability

© 1993 by Zilog, Inc. All rights reserved. No part of this document may be copied or reproduced in any form or by any means without the prior written consent of Zilog, Inc. The information in this document is subject to change without notice. Devices sold by Zilog, Inc. are covered by warranty and patent indemnification provisions appearing in Zilog, Inc. Terms and Conditions of Sale only. Zilog, Inc. makes no warranty, express, statutory, implied or by description, regarding the information set forth herein or regarding the freedom of the described devices from intellectual property infringement. Zilog, Inc. makes no warranty of merchantability or fitness for any purpose. Zilog, Inc. shall not be responsible for any errors that may appear in this document. Zilog, Inc. makes no commitment to update or keep current the information contained in this document. stated on the front and back of the acknowledgement, Zilog makes no claim as to quality and reliability under the CPS. The product remains subject to standard warranty for replacement due to defects in materials and workmanship.

Zilog's products are not authorized for use as critical components in life support devices or systems unless a specific written agreement pertaining to such intended use is executed between the customer and Zilog prior to use. Life support devices or systems are those which are intended for surgical implantation into the body, or which sustains life whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

Zilog, Inc. 210 East Hacienda Ave. Campbell, CA 95008-6600 Telephone (408) 370-8000 Telex 910-338-7621 FAX 408 370-8056

STROBE MODE HANDSHAKE TIMING



Input Handshake Timing Strobed Mode



Output Handshake Timing Strobed Mode

AC ELECTRICAL CHARACTERISTICS

Strobe Mode Handshake Timing

No.	Symbol	Parameter	Notes (Data Direction)
1	TsDI(DAV)	Data In to Setup Time /DAV	ln
2	ThDAV(DI)	Data in Hold Time	In
3	TwDAV	/DAV Width	In
4	TdDO(DAV) Data Out to /DAV Delay		Out
5	TwDAV	Data Available Width	Out